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Datasheet

InnoLux

N173DSE-G31

CH-01-064

Doc. Number:

- Tentative Specification
- Preliminary Specification
- Approval Specification

MODEL NO.: N173DSE
SUFFIX: G31

Customer:	
APPROVED BY	SIGNATURE
Name / Title _____	_____
Note	
<hr/> Please return 1 copy for your confirmation with your signature and comments.	

Approved By	Checked By	Prepared By

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REVISION HISTORY

Version	Date	Page	Description
0.0	Apr. 24, 2015	All	Spec Ver.0.0 was first issued.

1. GENERAL DESCRIPTION

1.1 OVERVIEW

N173DSE-G31 is a 17.3" TFT Liquid Crystal Display module with LED Backlight unit and 40 pins eDP interface. This module supports 3840 x 2160 UHD mode and can display 16,777,216 colors. The optimum viewing angle is at 6 o'clock direction.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	17.3" diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	3840 x R.G.B. x 2160	pixel	-
Pixel Pitch	0.09945 (H) x 0.09945 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	16,777,216	color	-
Transmissive Mode	Normally black	-	-
Surface Treatment	Hard coating (3H), High Resolution Adaptable AG (Haze 24%)	-	-
Color Gamut	Adobe 100%	NTSC	-
Luminance, White	300	Cd/m2	-
Power Consumption	Total (TBD) W (Max.) @ Cell (TBD) W (Max.), BL (TBD) W (Max.)		(1)

Note (1) The specified power consumption (with converter efficiency) is under the conditions at VCCS = 3.3 V, fv = 60 Hz, LED_VCCS = Typ, fPWM = 200 Hz, Duty=100% and Ta = 25 ± 2 °C, whereas mosaic pattern is displayed.

2. MECHANICAL SPECIFICATIONS

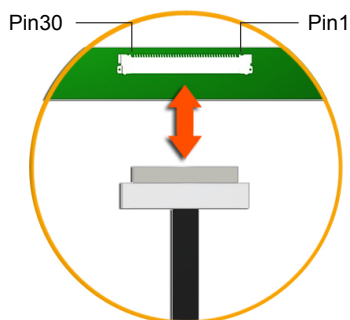
	Item	Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	399.0	399.5	400.0	mm	(1) (2)
	Vertical (V)	229.95	230.45	230.95	mm	
	Vertical (V) with PCB & Bracket	243.4-	243.9	244.4	mm	
	Thickness (T)	-	-	4.0	mm	
Polarizer Area	Horizontal	385.65	385.95	386.25	mm	
	Vertical	218.15	218.35	218.55	mm	
Active Area	Horizontal	.381.79	381.89	381.99-	mm	
	Vertical	214.71	214.81	214.91	mm	
	Weight	-	520	550	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

Note (2) Dimensions are measured by caliper.



2.1 CONNECTOR TYPE



Please refer Appendix Outline Drawing for detail design.

Connector Part No.: IPEX-20455-040E-12.

User's connector Part No: IPEX-20453-040T-01.

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

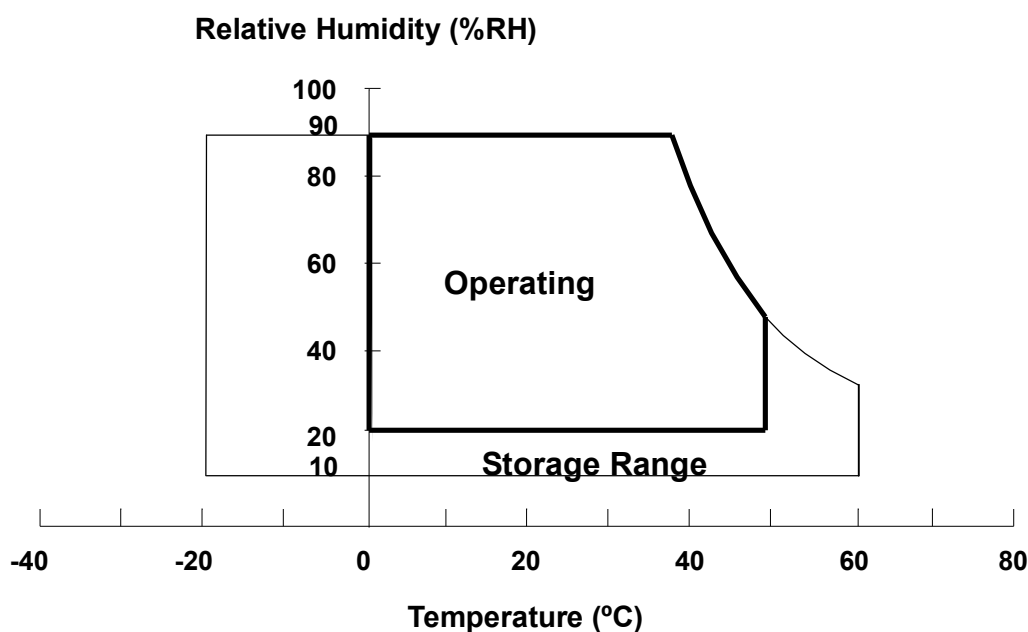
Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T _{ST}	-20	+60	°C	(1)
Operating Ambient Temperature	T _{OP}	0	+50	°C	(1), (2)

Note (1) (a) 90 %RH Max. (T_a < 40 °C).

(b) Wet-bulb temperature should be 39 °C Max.

(c) No condensation.

Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.



3.2 ELECTRICAL ABSOLUTE RATINGS

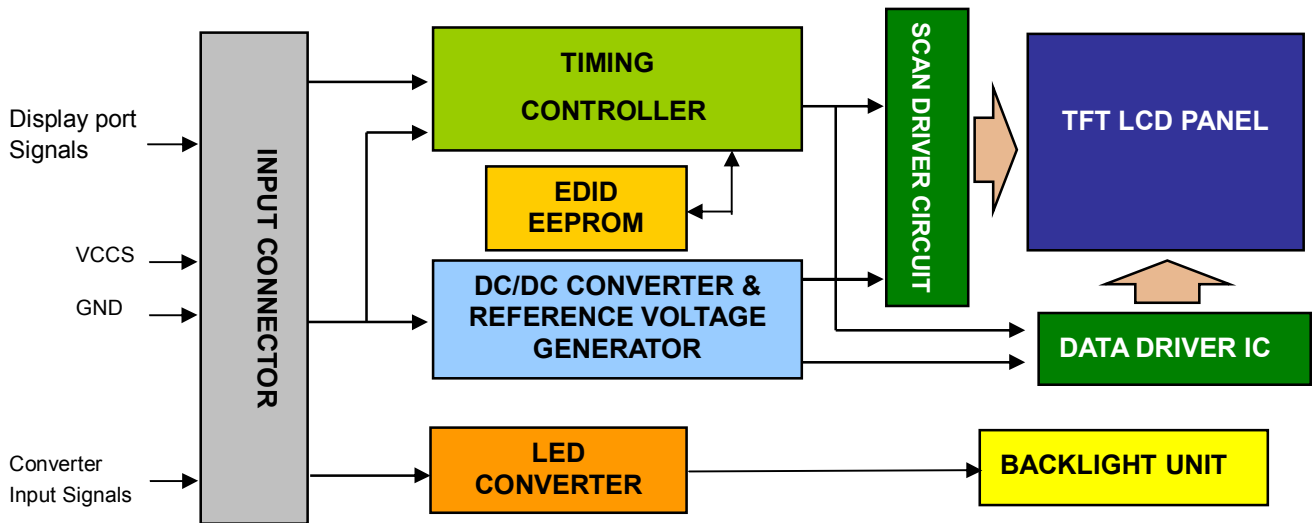
3.2.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	VCCS	-0.3	+4.0	V	(1)
Logic Input Voltage	V _{IN}	-0.3	VCCS+0.3	V	
Converter Input Voltage	LED_VCCS	-0.3	(TBD)	V	(1)
Converter Control Signal Voltage	LED_PWM,	-0.3	(TBD)	V	(1)
Converter Control Signal Voltage	LED_EN	-0.3	(TBD)	V	(1)

Note (1) Stresses beyond those listed in above “ELECTRICAL ABSOLUTE RATINGS” may cause permanent damage to the device. Normal operation should be restricted to the conditions described in “ELECTRICAL CHARACTERISTICS”.

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



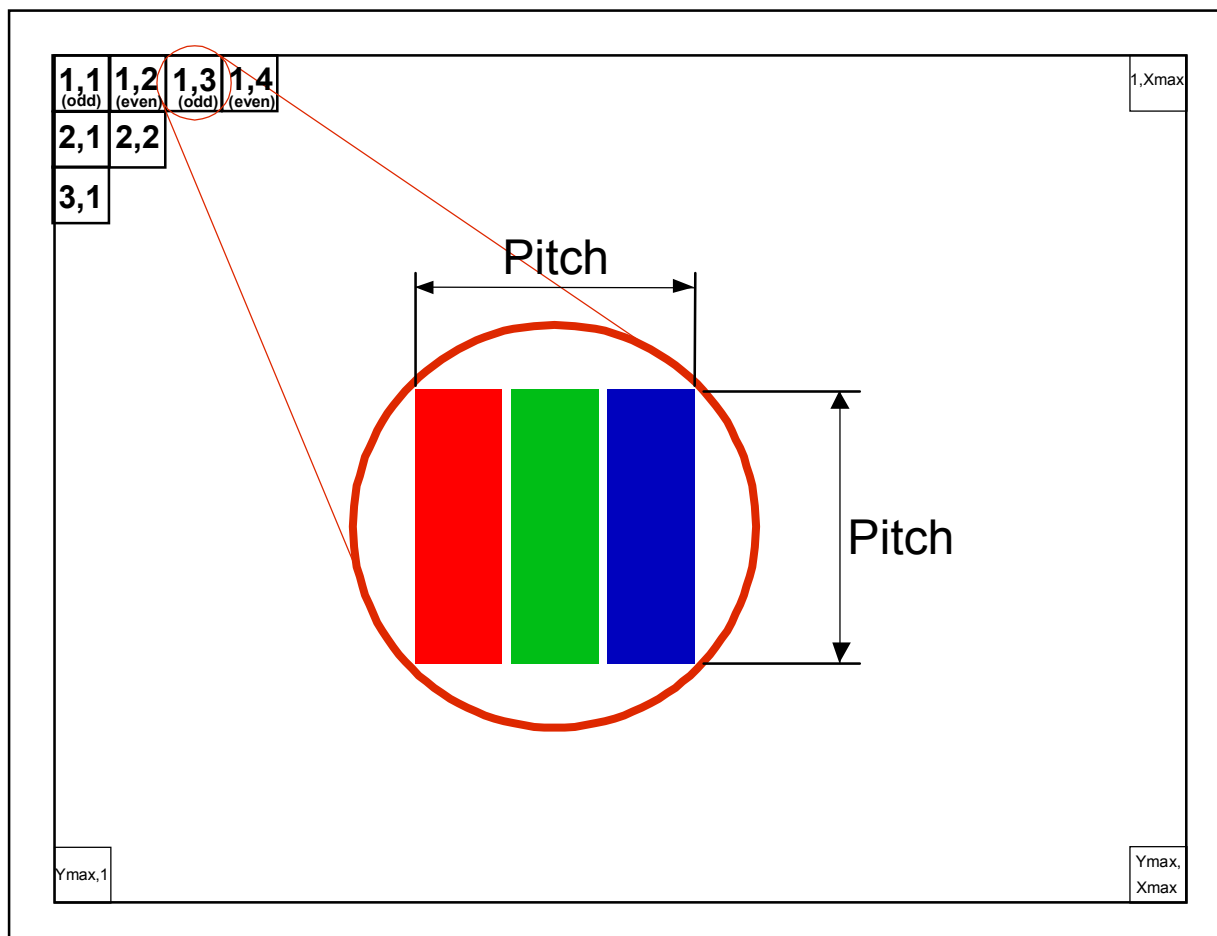
4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Symbol	Description	Remark
1	NC	No Connection (Reserved for LCD test)	
2	H_GND	High Speed Ground	
3	ML3-	Complement Signal-Lane 3	
4	ML3+	True Signal-Main Lane 3	
5	H_GND	High Speed Ground	
6	ML2-	Complement Signal-Lane 2	
7	ML2+	True Signal-Main Lane 2	
8	H_GND	High Speed Ground	
9	ML1-	Complement Signal-Lane 1	
10	ML1+	True Signal-Main Lane 1	
11	H_GND	High Speed Ground	
12	ML0-	Complement Signal-Lane 0	
13	ML0+	True Signal-Main Lane 0	
14	H_GND	High Speed Ground	
15	AUX+	True Signal-Auxiliary Channel	
16	AUX-	Complement Signal-Auxiliary Channel	
17	H_GND	High Speed Ground	
18	VCCS	Power Supply +3.3 V (typical)	
19	VCCS	Power Supply +3.3 V (typical)	
20	VCCS	Power Supply +3.3 V (typical)	
21	VCCS	Power Supply +3.3 V (typical)	
22	NC	No Connection (Reserved for LCD test)	
23	GND	Ground	
24	GND	Ground	
25	GND	Ground	

26	GND	Ground	
27	HPD	Hot Plug Detect	
28	BL_GND	BL Ground	
29	BL_GND	BL Ground	
30	BL_GND	BL Ground	
31	BL_GND	BL Ground	
32	LED_EN	BL_Enable Signal of LED Converter	
33	LED_PWM	PWM Dimming Control Signal of LED Converter	
34	NC	No Connection (Reserved for LCD test)	
35	NC	No Connection (Reserved for LCD test)	
36	LED_VCCS	BL Power	
37	LED_VCCS	BL Power	
38	LED_VCCS	BL Power	
39	LED_VCCS	BL Power	
40	NC	No Connection (Reserved for LCD test)	

Note (1) The first pixel is odd as shown in the following figure.



4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

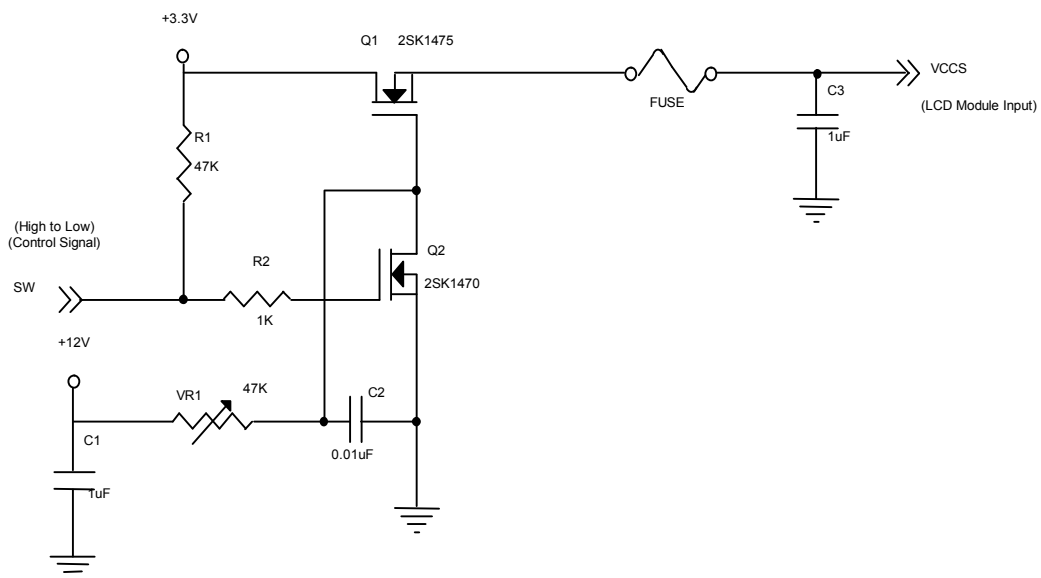
Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		VCCS	(3.0)	(3.3)	(3.6)	V	(1)
HPD	High Level		(TBD)	-	(TBD)	V	(4)
	Low Level		(TBD)	-	(TBD)	V	(4)
HPD Impedance		R _{HPD}	(TBD)			ohm	(4)
Ripple Voltage		V _{RP}	-	(TBD)	-	mV	(1)
Inrush Current		I _{RUSH}	-	-	(TBD)	A	(1),(2)
Power Supply Current	Mosaic	I _{CC}	-	(TBD)	(TBD)	mA	(3)a
	Black		-	(TBD)	(TBD)	mA	(3)

Note (1) The ambient temperature is Ta = 25 ± 2 °C.

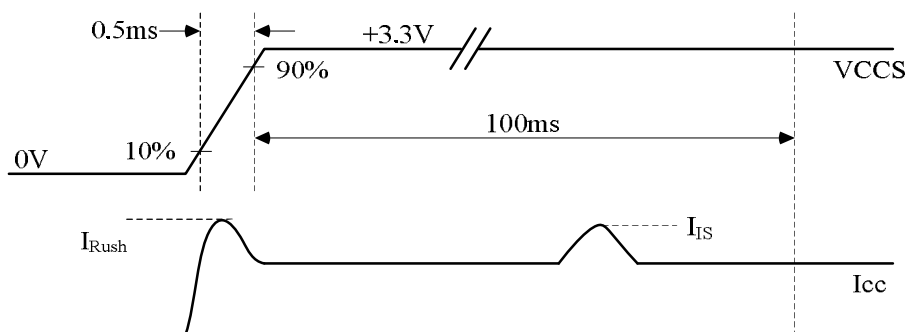
Note (2) I_{RUSH}: the maximum current when VCCS is rising

I_{IS}: the maximum current of the first 100ms after power-on

Measurement Conditions: Shown as the following figure. Test pattern: black.

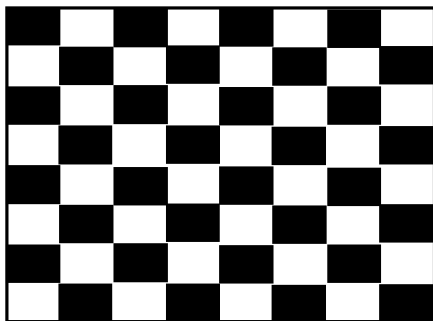


VCCS rising time is 0.5ms



Note (3) The specified power supply current is under the conditions at $V_{CCS} = 3.3\text{ V}$, $T_a = 25 \pm 2\text{ }^\circ\text{C}$, DC Current and $f_v = 60\text{ Hz}$, whereas a power dissipation check pattern below is displayed.

a. Mosaic Pattern



Active Area

Note (4) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. Please refer to Note (4) of 4.3.2 LED CONVERTER SPECIFICATION to obtain more information.

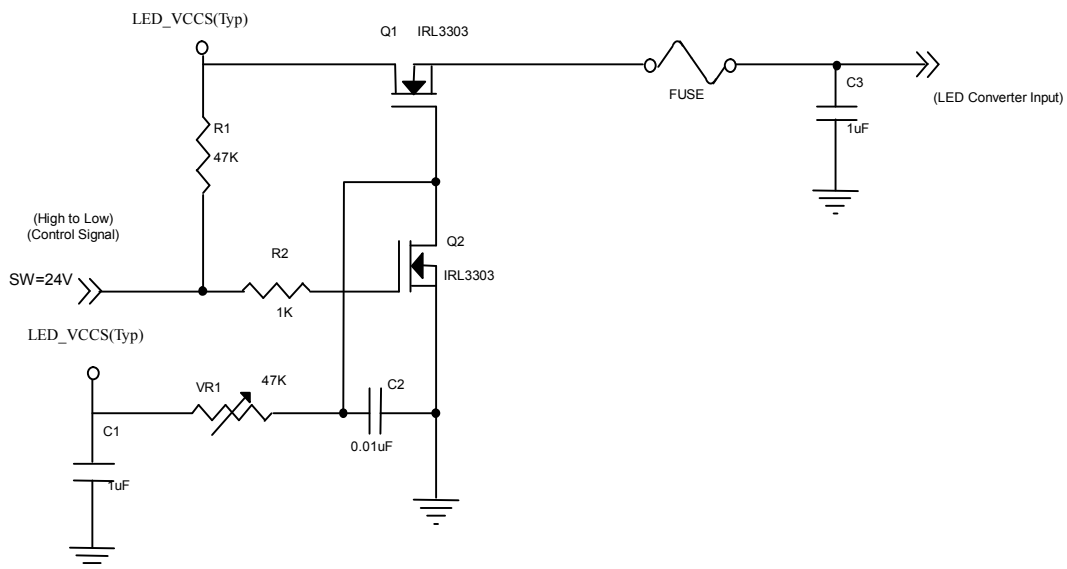
4.3.2 LED CONVERTER SPECIFICATION

Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Converter Input power supply voltage		LED_Vccs	(8)	(12.0)	(21.0)	V	
Converter Inrush Current		I _{LED_RUSH}	-	-	(1.5)	A	(1)
LED_EN Control Level	Backlight On		(2.2)	-	(5)	V	(4)
	Backlight Off		(0)	-	(0.6)	V	(4)
LED_EN Impedance		R _{LED_EN}	(30K)	-	-	ohm	(4)
PWM Control Level	PWM High Level		(2.2)	-	(5)	V	(4)
	PWM Low Level		(0)	-	(0.6)	V	(4)
PWM Impedance			(30K)	-	-	ohm	(4)
PWM Control Duty Ratio			(5)	-	(100)	%	
PWM Control Permissible Ripple Voltage		V _{PWM_pp}	-	-	(100)	mV	
PWM Control Frequency		f _{PWM}	(100)	-	(500)	Hz	(2)
LED Power Current	LED_VCCS =Typ.	I _{LED}	(TBD)	(TBD)	(TBD)	mA	(3)

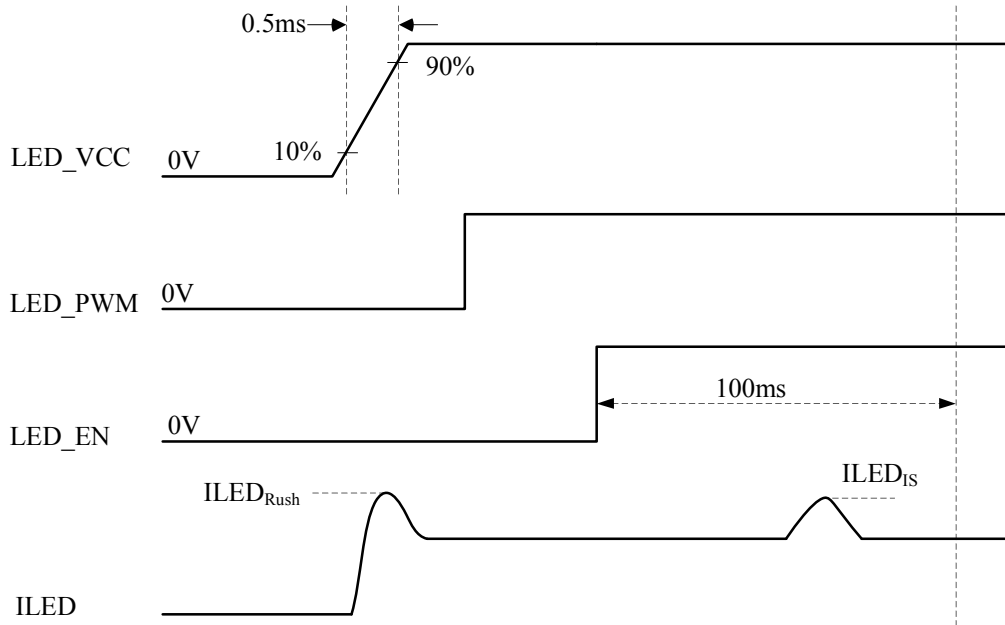
Note (1) I_{LED_RUSH}: the maximum current when LED_VCCS is rising,

I_{LED_IS}: the maximum current of the first 100ms after power-on,

Measurement Conditions: Shown as the following figure. LED_VCCS = Typ, Ta = 25 ± 2 °C, f_{PWM} = 200 Hz, Duty=100%.



VLED rising time is 0.5ms



Note (2) If PWM control frequency is applied in the range less than 1KHz, the “waterfall” phenomenon on the screen may be found. To avoid the issue, it’s a suggestion that PWM control frequency should follow the criterion as below.

PWM control frequency f_{PWM} should be in the range

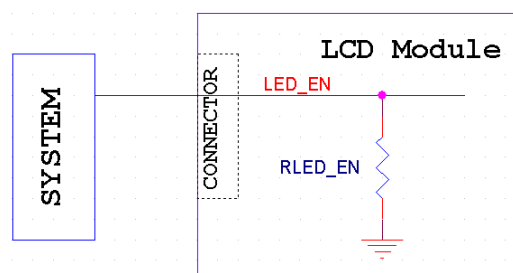
$$(N + 0.33) * f \leq f_{PWM} \leq (N + 0.66) * f$$

N : Integer ($N \geq 3$)

f : Frame rate

Note (3) The specified LED power supply current is under the conditions at “LED_VCCS = Typ.”, $T_a = 25 \pm 2 \text{ }^\circ\text{C}$, $f_{PWM} = 200 \text{ Hz}$, Duty=100%.

Note (4) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. For example, the figure below describes the equivalent pull down impedance of LED_EN (If it exists). The rest pull down impedances of other signals (eg. HPD, PWM ...) are in the same concept.

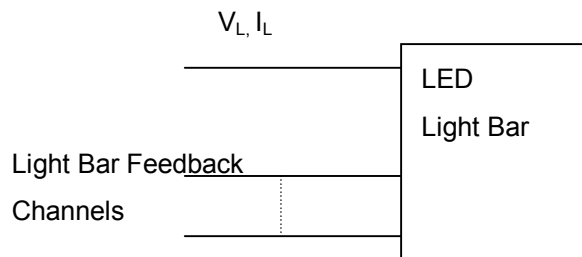


4.3.3 BACKLIGHT UNIT

Ta = 25 ± 2 °C

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LED Light Bar Power Supply Voltage	V _L	28.6	31.9	33.0	V	(1)(2)(Duty100%)
LED Light Bar Power Supply Current	I _L	-	187.2	-	mA	
Power Consumption	P _L	-	5.971	6.177	W	(3)
LED Life Time	L _{BL}	15000	-	-	Hrs	(4)

Note (1) LED current is measured by utilizing a high frequency current meter as shown below :



Note (2) For better LED light bar driving quality, it is recommended to utilize the adaptive boost converter with current balancing function to drive LED light-bar.

Note (3) $P_L = I_L \times V_L$ (Without LED converter transfer efficiency)

Note (4) The lifetime of LED is defined as the time when it continues to operate under the conditions at Ta = 25 ± 2 °C and I_L = 23.4 mA (Per EA) until the brightness becomes ≤ 50% of its original value.

4.4 DISPLAY PORT SIGNAL TIMING SPECIFICATION

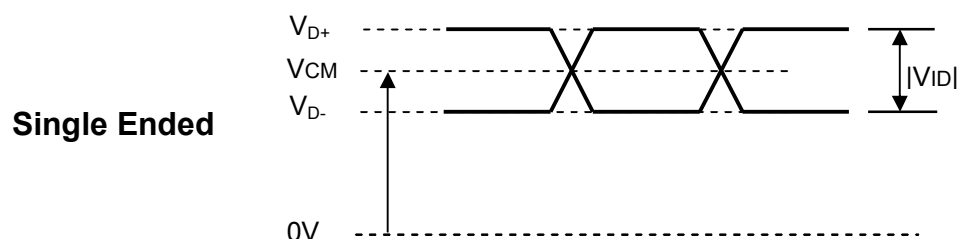
4.4.1 DISPLAY PORT INTERFACE

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Differential Signal Common Mode Voltage(MainLink and AUX)	VCM	0	-	2	V	(1)(3)
AUX AC Coupling Capacitor	C _{AUX}	75	-	200	nF	(2)

Note (1) Display port interface related AC coupled signals should follow VESA DisplayPort Standard Version 1.1, Revision 1a and VESA Embedded DisplayPort™ Standard Version 1.2. There are many optional items described in eDP1.2. If some optional item is requested, please contact us.

(2) The AUX AC Coupling Capacitor should be placed on Source Devices.

(3) The source device should pass the test criteria described in DisplayPort Compliance Test Specification (CTS) 1.1



4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

Color		Data Signal																	
		Red						Green						Blue					
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	
	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	
Gray Scale Of Green	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	
	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	
	Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	
Gray Scale Of Blue	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	
	Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	

Note (1) 0: Low Level Voltage, 1: High Level Voltage

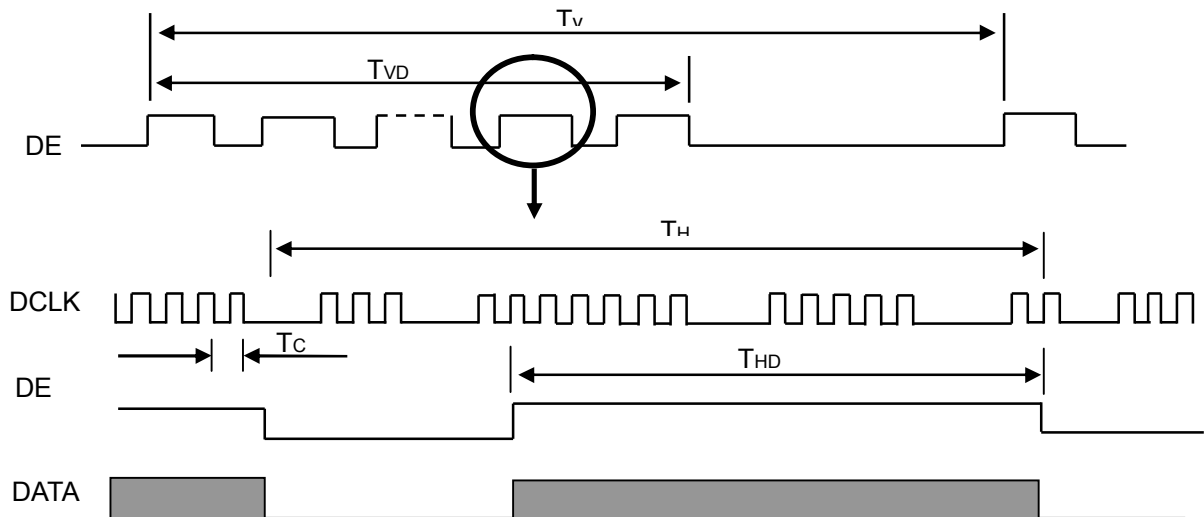
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Refresh rate 60Hz

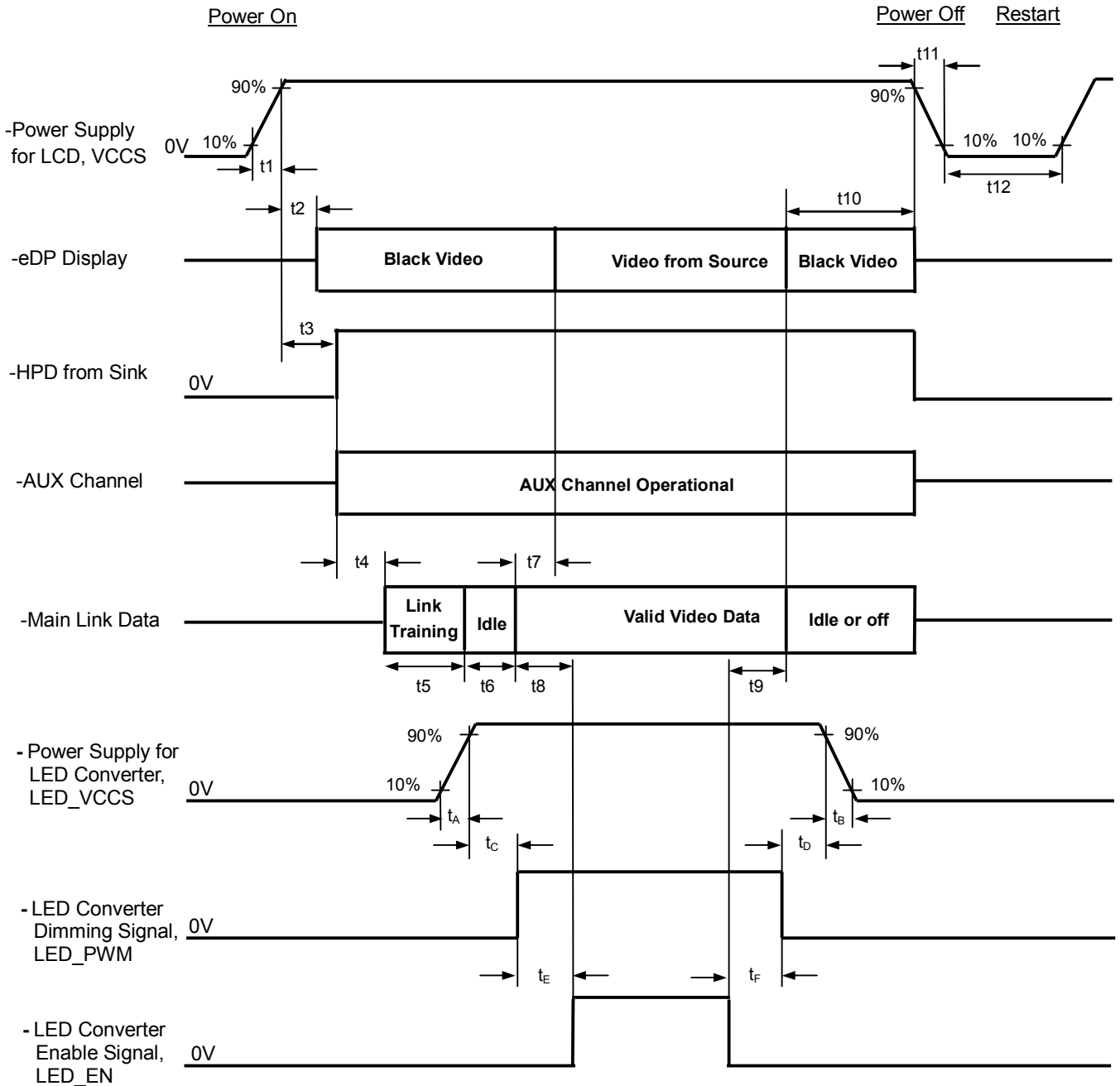
Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
DCLK	Frequency	1/Tc	(TBD)	(TBD)	(TBD)	MHz	-
DE	Vertical Total Time	TV	(TBD)	(TBD)	(TBD)	TH	-
	Vertical Active Display Period	TVD	(TBD)	(TBD)	(TBD)	TH	-
	Vertical Active Blanking Period	TVB	TV-TVD	(TBD)	TV-TVD	TH	-
	Horizontal Total Time	TH	(TBD)	(TBD)	(TBD)	Tc	-
	Horizontal Active Display Period	THD	(TBD)	(TBD)	(TBD)	Tc	-
	Horizontal Active Blanking Period	THB	TH-THD	(TBD)	TH-THD	Tc	-

INPUT SIGNAL TIMING DIAGRAM



4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameter	Description	Reqd. By	Value		Unit	Notes
			Min	Max		
t1	Power rail rise time, 10% to 90%	Source	(TBD)	(TBD)	ms	-
t2	Delay from LCD,VCCS to black video generation	Sink	(TBD)	(TBD)	ms	Automatic Black Video generation prevents display noise until valid video data is received from the Source (see Notes:2 and 3 below)
t3	Delay from LCD,VCCS to HPD high	Sink	(TBD)	(TBD)	ms	Sink AUX Channel must be operational upon HPD high (see Note:4 below)
t4	Delay from HPD high to link training initialization	Source	-	-	ms	Allows for Source to read Link capability and initialize
t5	Link training duration	Source	-	-	ms	Dependant on Source link training protocol
t6	Link idle	Source	-	-	ms	Min Accounts for required BS-Idle pattern. Max allows for Source frame synchronization
t7	Delay from valid video data from Source to video on display	Sink	(TBD)	(TBD)	ms	Max value allows for Sink to validate video data and timing. At the end of T7, Sink will indicate the detection of valid video data by setting the SINK_STATUS bit to logic 1 (DPCD 00205h, bit 0), and Sink will no longer generate automatic Black Video
t8	Delay from valid video data from Source to backlight on	Source	-	-	ms	Source must assure display video is stable
t9	Delay from backlight off to end of valid video data	Source	-	-	ms	Source must assure backlight is no longer illuminated. At the end of T9, Sink will indicate the detection of no valid video data by setting the SINK_STATUS bit to logic 0 (DPCD 00205h, bit 0), and Sink will automatically display Black Video. (See Notes: 2 and 3 below)
t10	Delay from end of valid video data from Source to power off	Source	(TBD)	(TBD)	ms	Black video will be displayed after receiving idle or off signals from Source
t11	VCCS power rail fall time, 90% to 10%	Source	(TBD)	(TBD)	ms	-
t12	VCCS Power off time	Source	(TBD)	-	ms	-
t _A	LED power rail rise time, 10% to 90%	Source	(TBD)	(TBD)	ms	-
t _B	LED power rail fall time, 90% to 10%	Source	(TBD)	(TBD)	ms	-

t_c	Delay from LED power rising to LED dimming signal	Source	(TBD)	-	ms	-
t_d	Delay from LED dimming signal to LED power falling	Source	(TBD)	-	ms	-
t_e	Delay from LED dimming signal to LED enable signal	Source	(TBD)	-	ms	-
t_f	Delay from LED enable signal to LED dimming signal	Source	(TBD)	-	ms	-

Note (1) Please don't plug or unplug the interface cable when system is turned on.

Note (2) The Sink must include the ability to automatically generate Black Video autonomously. The Sink must automatically enable Black Video under the following conditions:

- Upon LCDVCC power-on (within T2 max)
- When the "NoVideoStream_Flag" (VB-ID Bit 3) is received from the Source (at the end of T9)

Note (3) The Sink may implement the ability to disable the automatic Black Video function, as described in Note (2), above, for system development and debugging purposes.

Note (4) The Sink must support AUX Channel polling by the Source immediately following LCDVCC power-on without causing damage to the Sink device (the Source can re-try if the Sink is not ready). The Sink must be able to response to an AUX Channel transaction with the time specified within T3 max.

5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

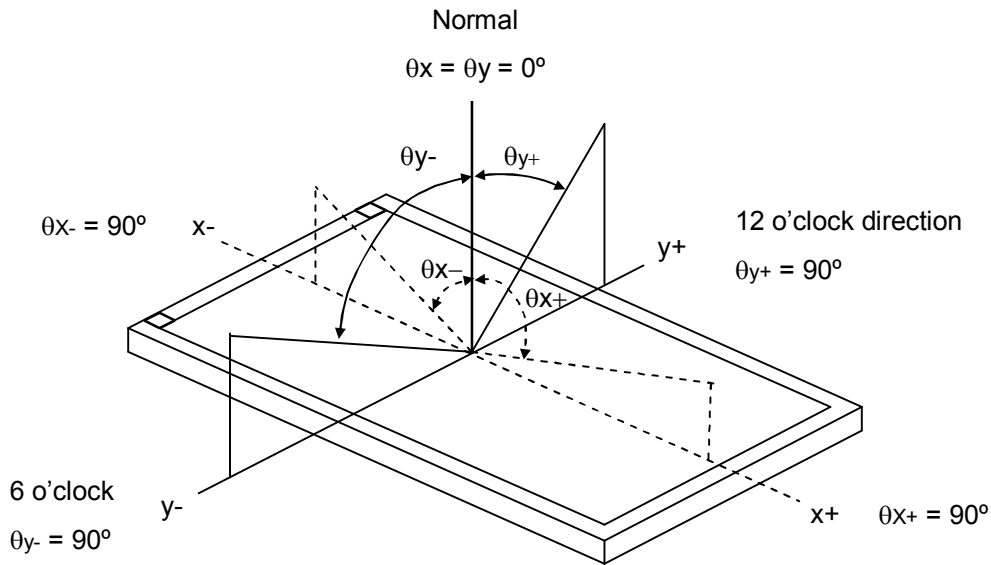
Item	Symbol	Value	Unit
Ambient Temperature	T _a	25±2	°C
Ambient Humidity	H _a	50±10	%RH
Supply Voltage	V _{CC}	3.3	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Light Bar Input Current	I _L	187.2	mA

The measurement methods of optical characteristics are shown in Section 5.2. The following items should be measured under the test conditions described in Section 5.1 and stable environment shown in Note (5).

5.2 OPTICAL SPECIFICATIONS

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio		CR	θ _x =0°, θ _y =0° Viewing Normal Angle	600	800	-	-	(2), (5), (7)
Response Time		T _R		-	14	16	ms	(3), (7)
		T _F		-	11	15	ms	
Average Luminance of White		L _{Ave}		255	300	-	cd/m ²	(4), (6), (7)
Color Chromaticity	Red	R _x		Typ - 0.03	(0.640)	Typ + 0.03	-	(1), (7)
		R _y			(0.330)		-	
	Green	G _x			(0.210)		-	
		G _y			(0.710)		-	
	Blue	B _x			(0.150)		-	
		B _y			(0.060)		-	
	White	W _x	0.313		-			
		W _y	0.329		-			
Viewing Angle	Horizontal	θ _{x+}	80	89	-	Deg.	(1), (5), (7)	
		θ _{x-}	80	89	-			
	Vertical	θ _{y+}	80	89	-			
		θ _{y-}	80	89	-			
White Variation		δW _{5p}	θ _x =0°, θ _y =0°	80	90	-	%	(5), (6), (7)
		δW _{13p}	θ _x =0°, θ _y =0°	65	75	-	%	(5), (6), (7)

Note (1) Definition of Viewing Angle (θ_x, θ_y):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = L_{63} / L_0$$

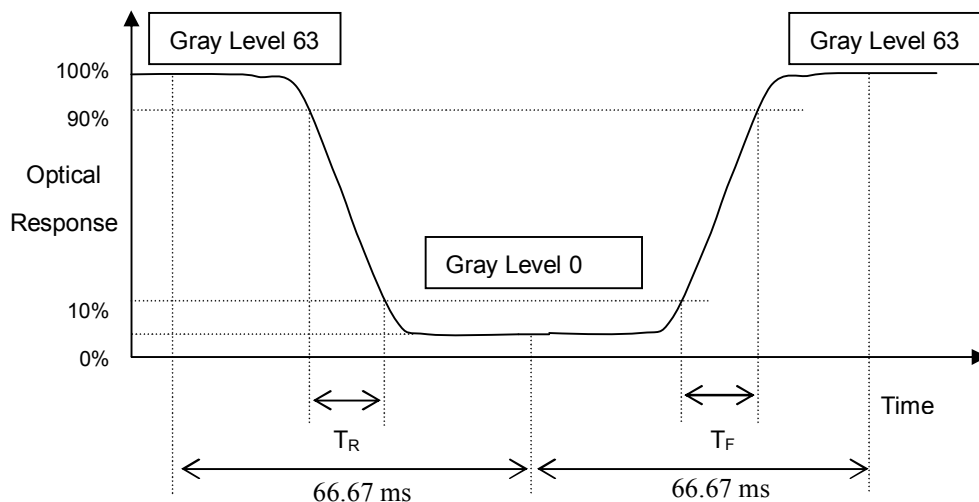
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

$$\text{CR} = \text{CR} (1)$$

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time (T_R, T_F):



Note (4) Definition of Average Luminance of White (L_{AVE}):

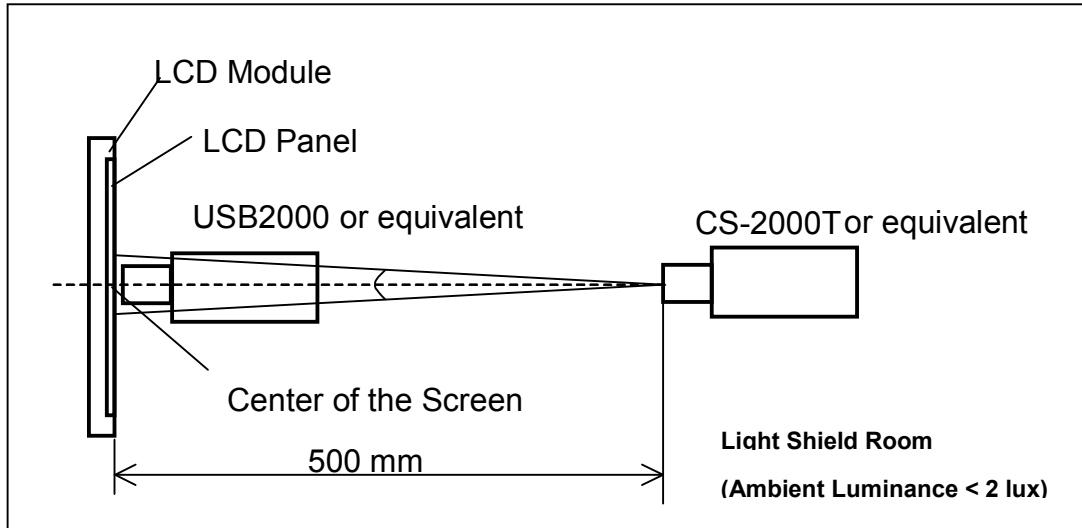
Measure the luminance of gray level 63 at 5 points

$$L_{AVE} = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5$$

L (x) is corresponding to the luminance of the point X at Figure in Note (6)

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.

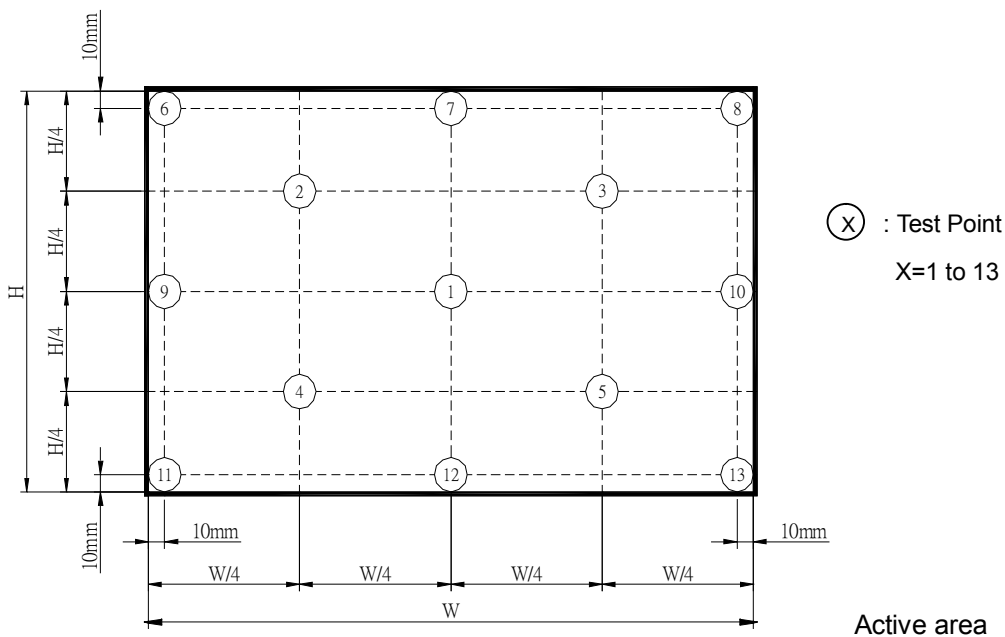


Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 63 at 5 points

$$\delta W_{5p} = \{ \text{Minimum} [L(1) \sim L(5)] / \text{Maximum} [L(1) \sim L(5)] \} * 100\%$$

$$\delta W_{13p} = \{ \text{Minimum} [L(1) \sim L(13)] / \text{Maximum} [L(1) \sim L(13)] \} * 100\%$$



Note (7) The listed optical specifications refer to the initial value of manufacture, but the condition of the specifications after long-term operation will not be warranted.

6. RELIABILITY TEST ITEM

Test Item	Test Condition	Note
High Temperature Storage Test	60°C, 240 hours	(1) (2)
Low Temperature Storage Test	-20°C, 240 hours	
Thermal Shock Storage Test	-20°C, 0.5hour \longleftrightarrow 60°C, 0.5hour; 100cycles, 1hour/cycle	
High Temperature Operation Test	50°C, 240 hours	
Low Temperature Operation Test	0°C, 240 hours	
High Temperature & High Humidity Operation Test	50°C, RH 80%, 240hours	
ESD Test (Operation)	150pF, 330 Ω , 1sec/cycle Condition 1 : Contact Discharge, \pm 8KV Condition 2 : Air Discharge, \pm 15KV	(1)
Shock (Non-Operating)	220G, 2ms, half sine wave, 1 time for each direction of \pm X, \pm Y, \pm Z	(1)(3)
Vibration (Non-Operating)	1.5G / 10-500 Hz, Sine wave, 30 min/cycle, 1cycle for each X, Y, Z	(1)(3)

Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

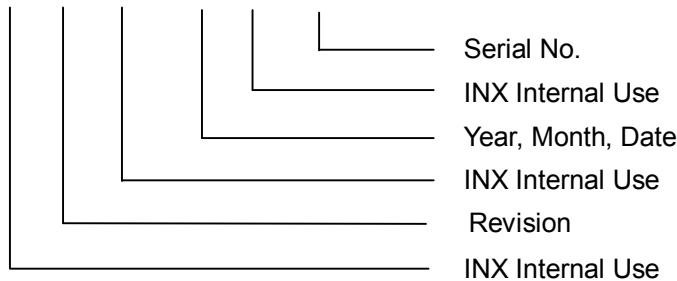
7. PACKING

7.1 MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



- (a) Model Name: N173DSE-G31
- (b) Revision: Rev. XX, for example: C1, C2 ...etc.
- (c) Serial ID: XXXXXXYMDXXXX



- (d) Production Location: MADE IN XXXX.
- (e) UL logo: “XXXX” especially stands for panel manufactured by INX satisfying UL requirement.

Serial ID includes the information as below:

- (a) Manufactured Date: Year: 1~9, for 2011~2019
 Month: 1~9, A~C, for Jan. ~ Dec.
 Day: 1~9, A~Y, for 1st to 31st, exclude I , O and U
- (b) Revision Code: cover all the change
- (c) Serial No.: Manufacturing sequence of product

7.2 CARTON

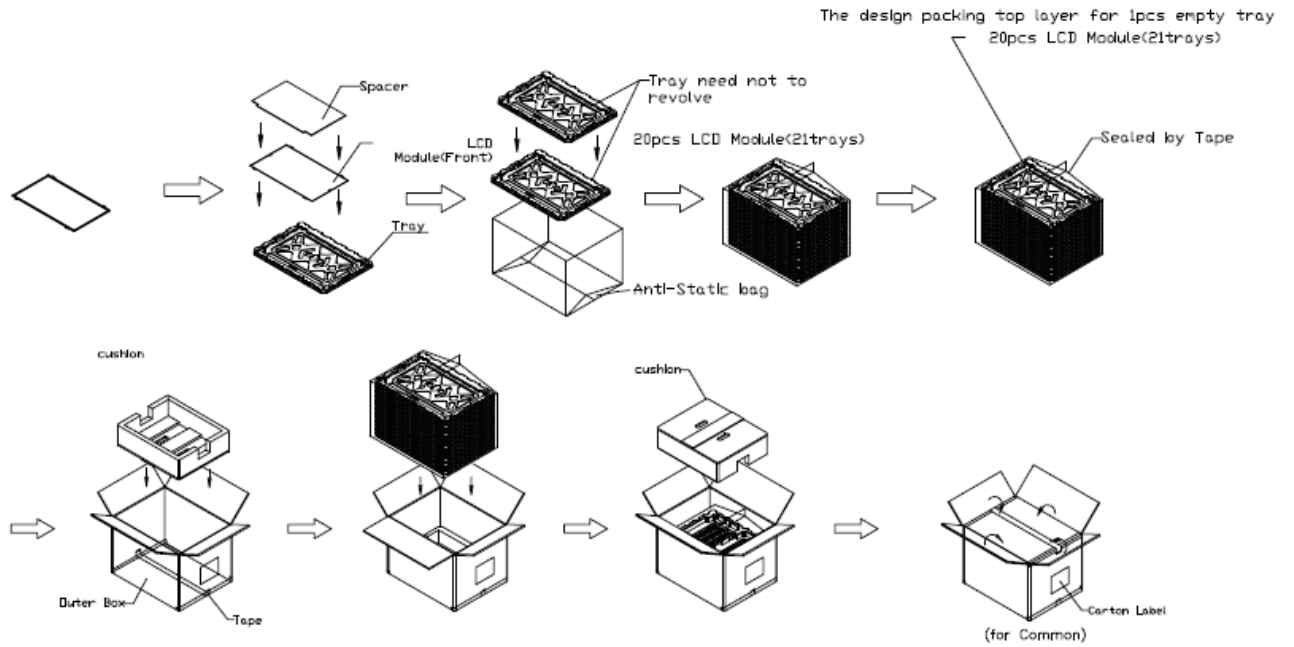


Figure. 7-1 Packing method

7.3 PALLET

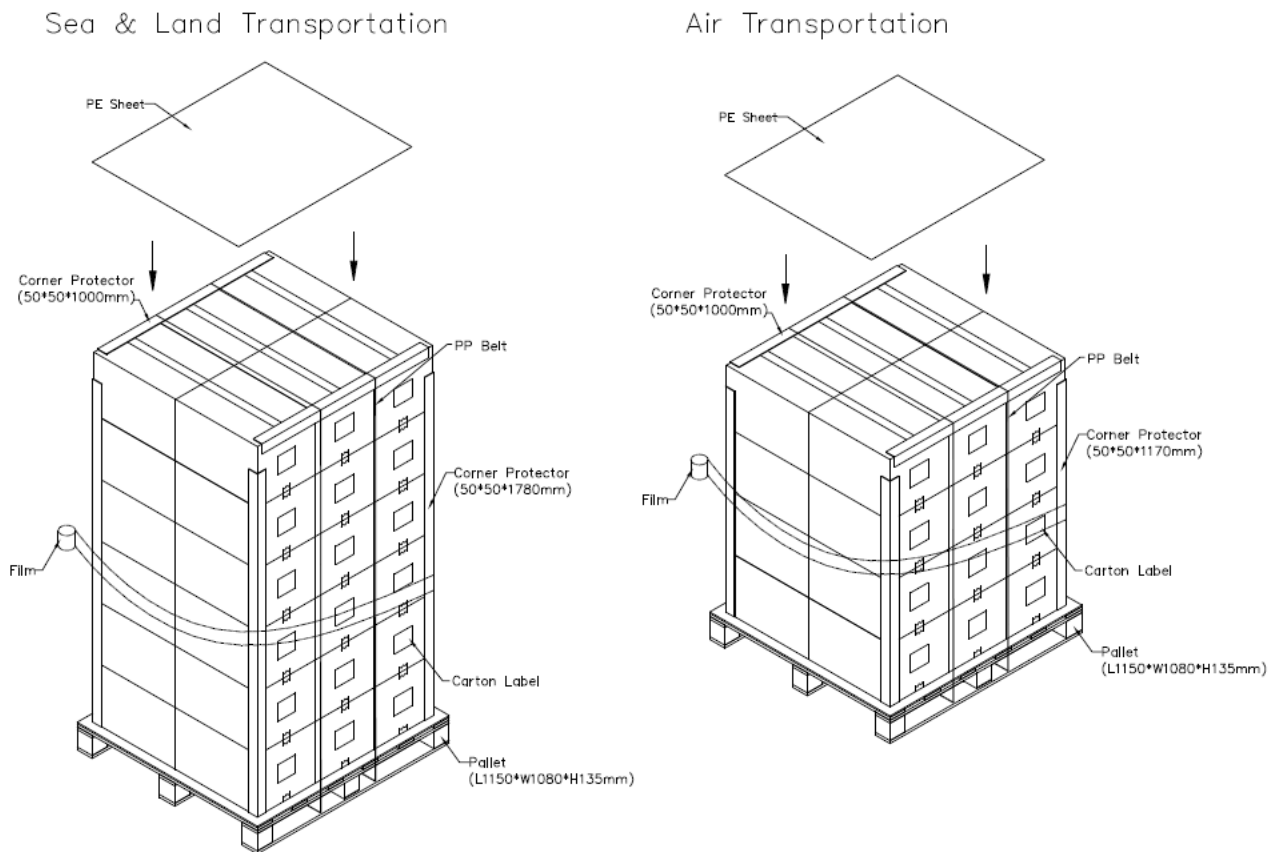


Figure. 7-2 Packing method

7.4 UN-PACKAGING METHOD

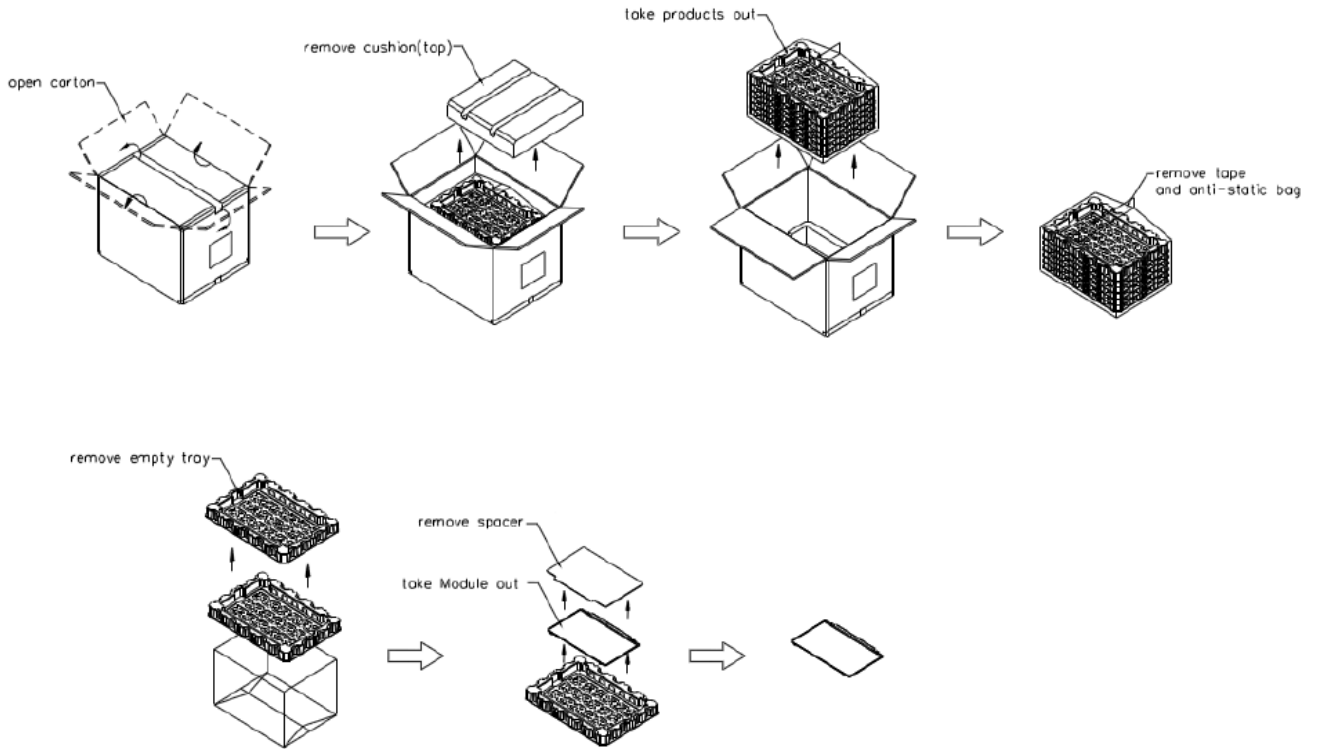


Figure. 7-3 Un-Packing method

8. PRECAUTIONS

8.1 HANDLING PRECAUTIONS

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the LED wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

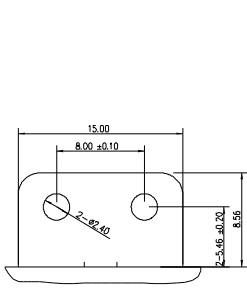
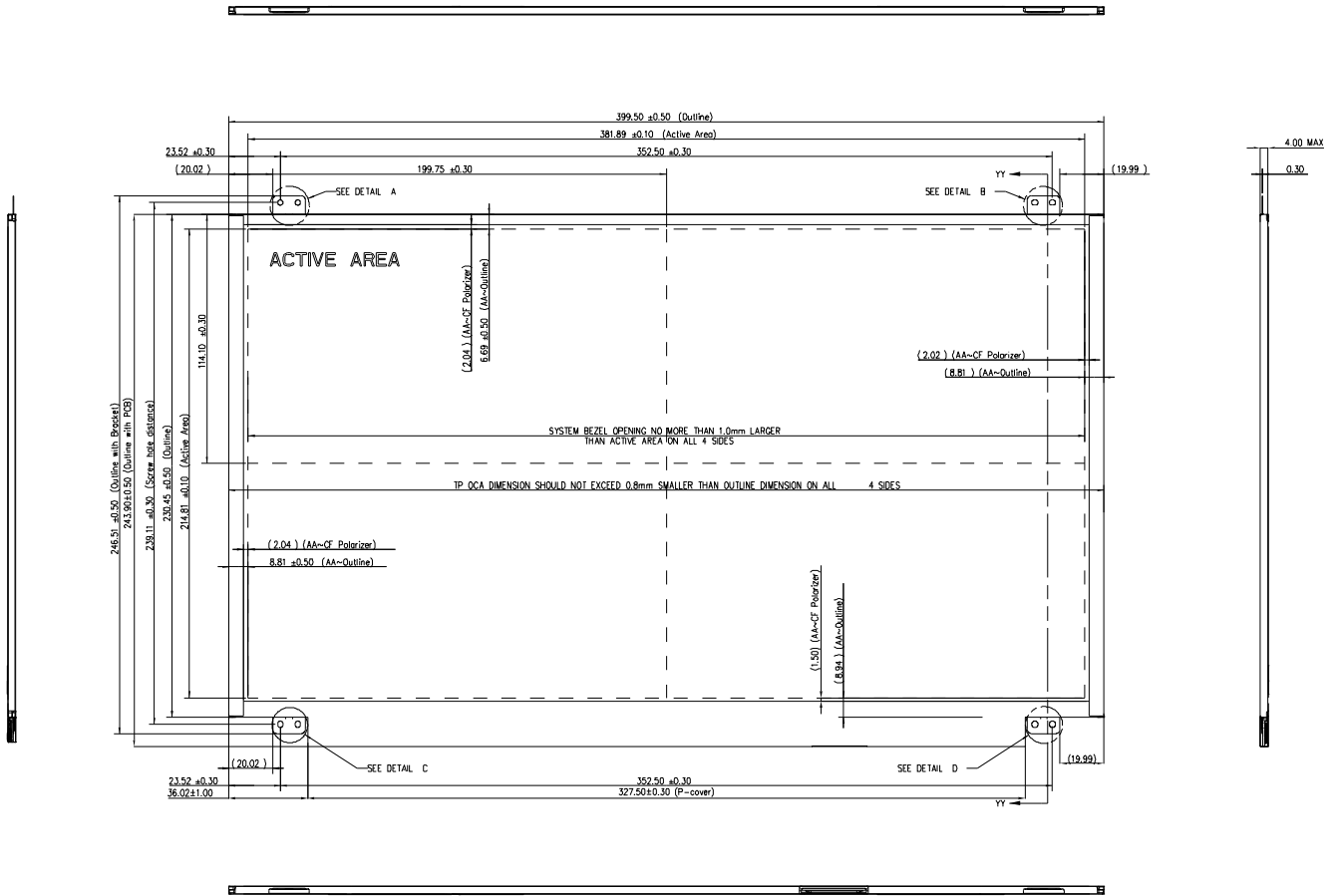
8.2 STORAGE PRECAUTIONS

- (1) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (2) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (3) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the response time will become slowly, and the starting voltage of LED will be higher than the room temperature.

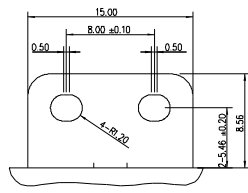
8.3 OPERATION PRECAUTIONS

- (1) Do not pull the I/F connector in or out while the module is operating.
- (2) Always follow the correct power on/off sequence when LCD module is connecting and operating. This can prevent the CMOS LSI chips from damage during latch-up.
- (3) The startup voltage of Backlight is approximately 1000 Volts. It may cause electrical shock while assembling with converter. Do not disassemble the module or insert anything into the Backlight unit.

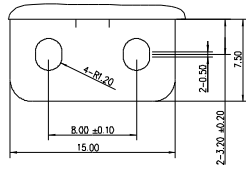
Appendix. OUTLINE DRAWING



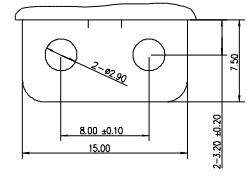
DETAIL A
SCALE 5:1



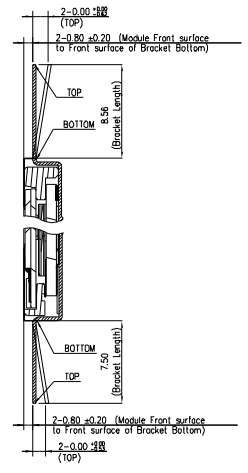
DETAIL B
SCALE 5:1



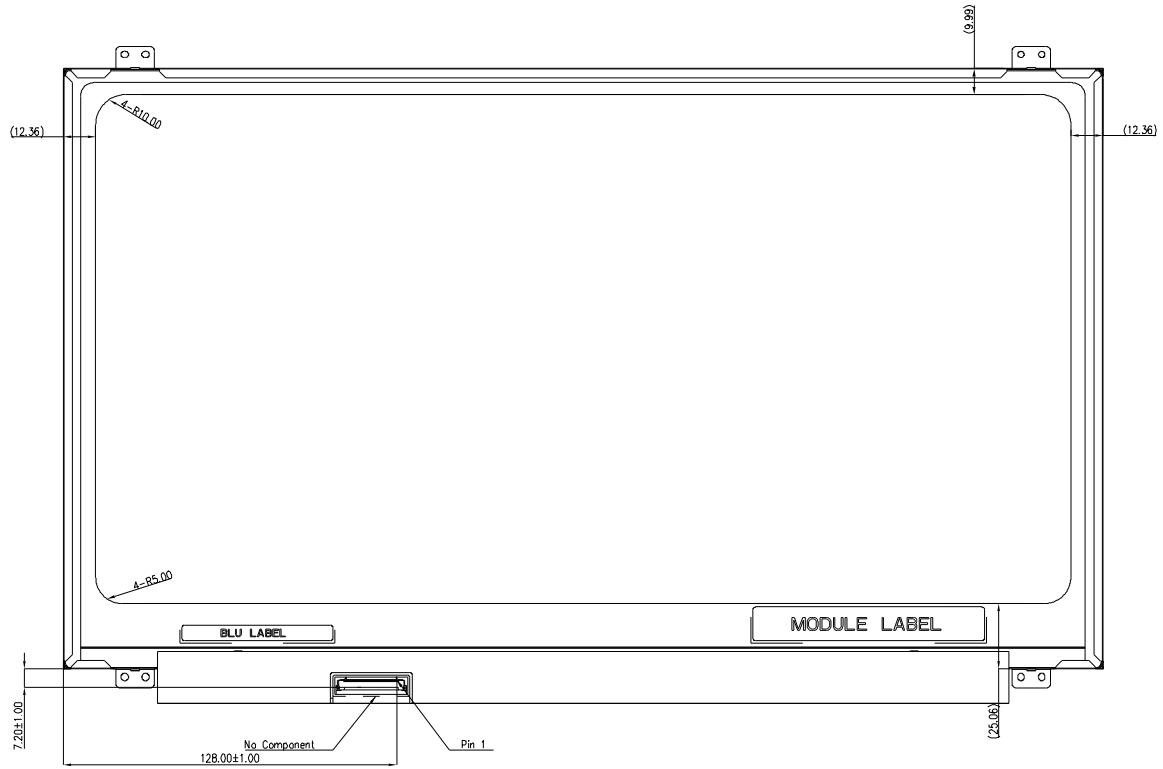
DETAIL C
SCALE 5:1



DETAIL D
SCALE 5:1



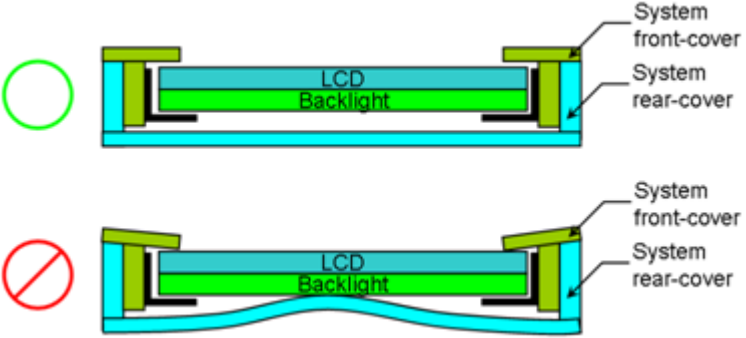
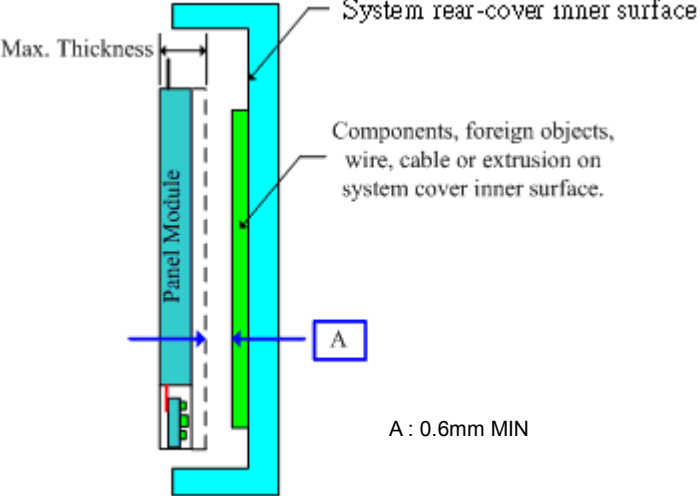
SECTION YY-YY
SCALE 5:1

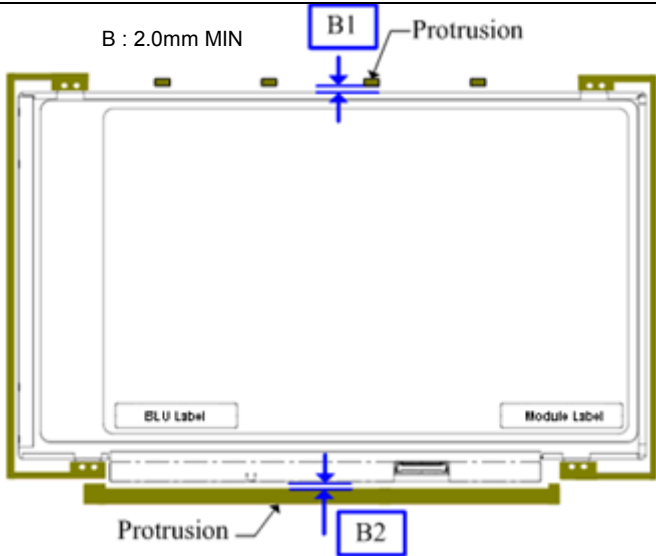
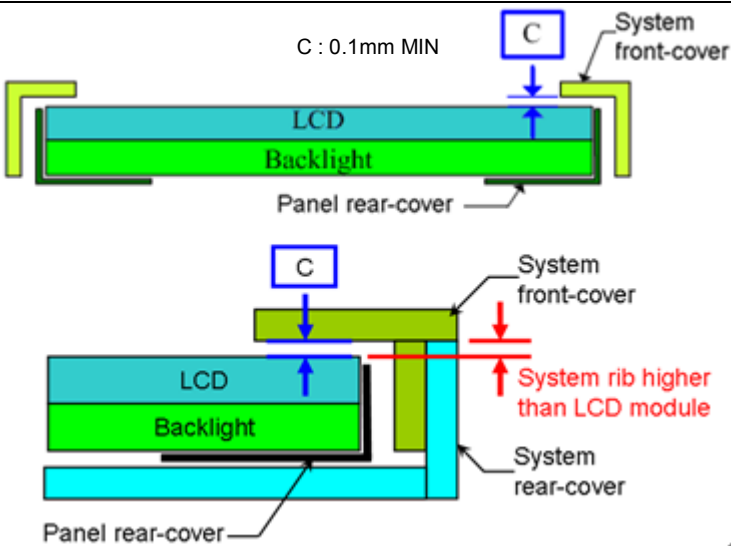
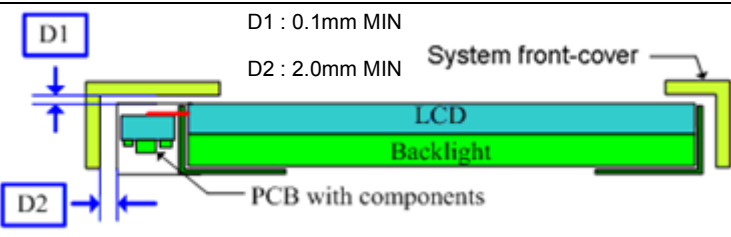


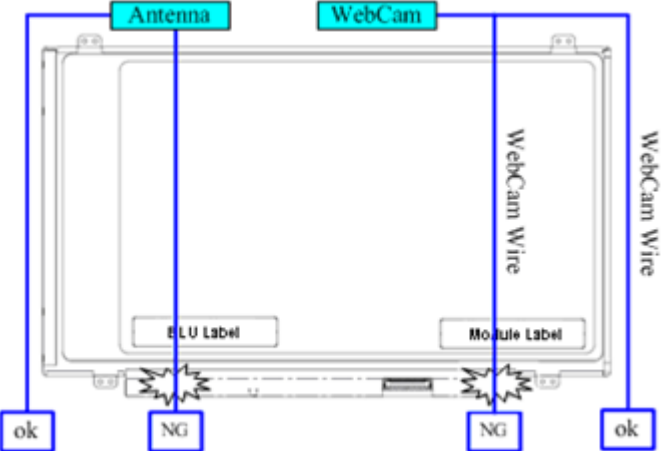
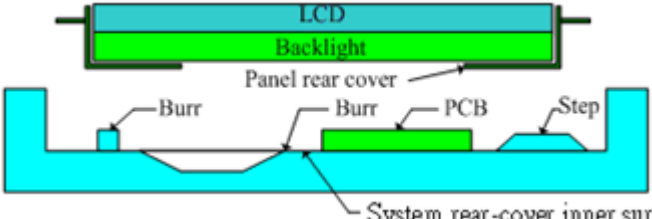
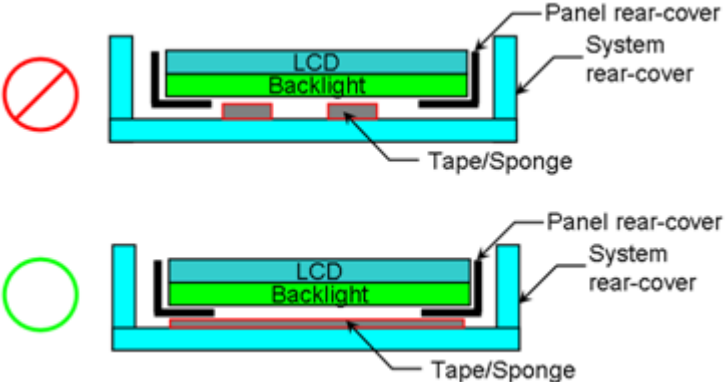
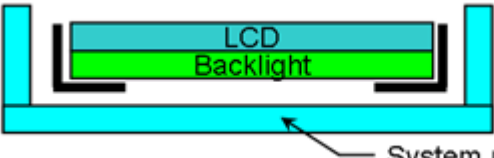
NOTES :

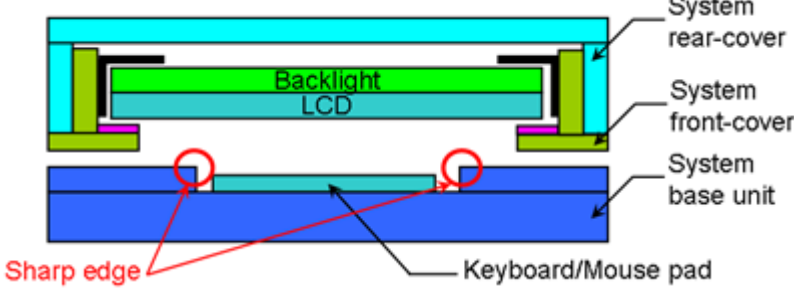
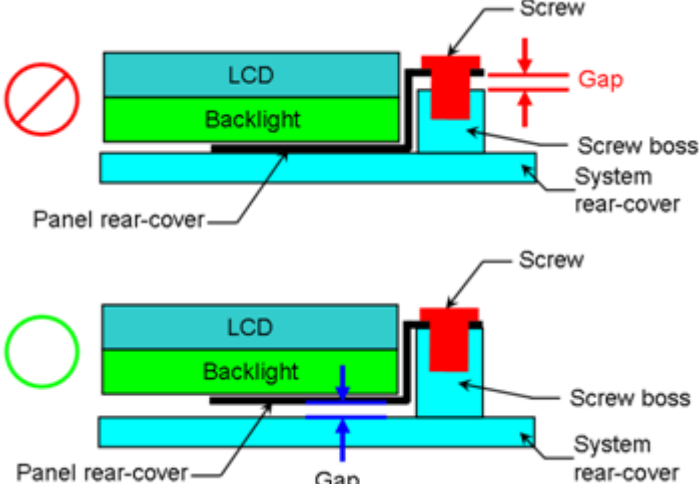
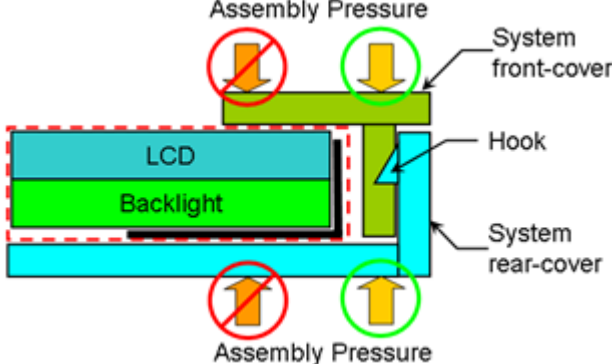
1. LCD MODULE INPUT CONNECTOR : 20455-040E-12 (I-PEX)
2. IN ORDER TO AVOID ABNORMAL DISPLAY, POOLING AND WHITE SPOT, NO OVERLAPPING IS SUGGESTED AT CABLES, ANTENNAS, CAMERA, WLAN, WAN OR FOREIGN OBJECTS OVER FPC/COF, T-CON AND VR LOCATIONS.
3. LVDS/EDP CONNECTOR IS MEASURED AT PIN1 AND ITS MATING LINE.
4. MODULE FLATNESS SPEC 2.00 MM MAX. (SPEC. WILL BE MODIFIED AFTER DVT CHECK).
5. () MARKS THE REFERENCE DIMENSION.

Appendix. SYSTEM COVER DESIGN NOTICE

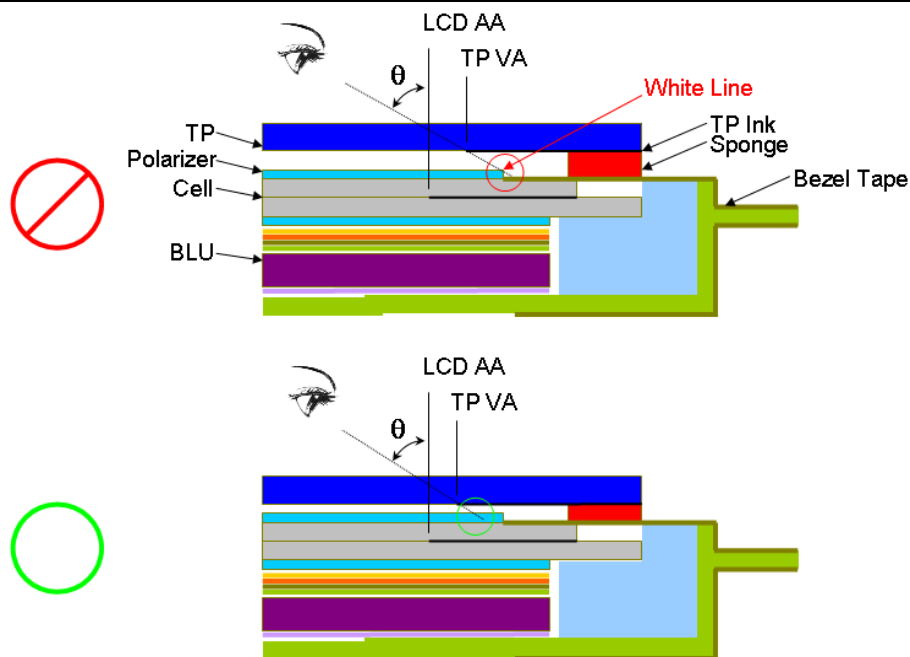
0.	Permanent deformation of system cover after reliability test
	
Definition	System cover including front and rear cover may deform during reliability test. Permanent deformation of system front and rear cover after reliability test should not interfere with panel. Because it may cause issues such as pooling, abnormal display, white spot, and also cell crack.
1.	Design gap A between panel & any components on system rear-cover
	
Definition	Gap between panel's maximum thickness boundary & system's inner surface components such as wire, cable, extrusion is needed for preventing from backpack or pogo test fail. Because zero gap or interference may cause stress concentration. Issues such as pooling, abnormal display, white spot, and cell crack may occur. Flatness of panel and system rear-cover should be taken into account for gap design.
2	Design gap B1 & B2 between panel & protrusions

	
<p>Definition</p>	<p>Gap between panel & protrusions is needed to prevent shock test failure. Because protrusions with small gap may hit panel during the test. Issue such as cell crack, abnormal display may occur.</p>
<p>3</p>	<p>Design gap C between system front-cover & panel surface.</p>
	
<p>Definition</p>	<p>Gap between system front-cover & panel surface is needed to prevent pooling or glass broken. Zero gap or interference such as burr and warpage from mold frame may cause pooling issue near system font-cover opening edge. This phenomenon is obvious during swing test, hinge test, knock test, or during pooling inspection procedure. To remain sufficient gap, design with system rib higher than maximum panel thickness is recommended.</p>
<p>4</p>	<p>Design gap D1 & D2 between system front-cover & PCB Assembly.</p>
	
<p>Definition</p>	<p>Same as point 2 and 3, but focus on PCBA side.</p>

5	Interference examination of antenna cable and WebCam wire
	
Definition	Antenna cable or WebCam wire should not overlap with panel outline. Because issue such as abnormal display & white spot after backpack test, hinge test, twist test or pogo test may occur.
6	System rear-cover inner surface examination
	
Definition	Burr at logo edge, steps, protrusions or PCB board may cause stress concentration. White spot or glass broken issue may occur during reliability test.
7	Tape/sponge design on system inner surface
	
Definition	To prevent abnormal display & white spot after scuffing test, hinge test, pogo test, backpack test, tape/sponge should be well covered under panel rear-cover. Because tape/sponge in separate location may act as pressure concentration location.
8	Material used for system rear-cover
	

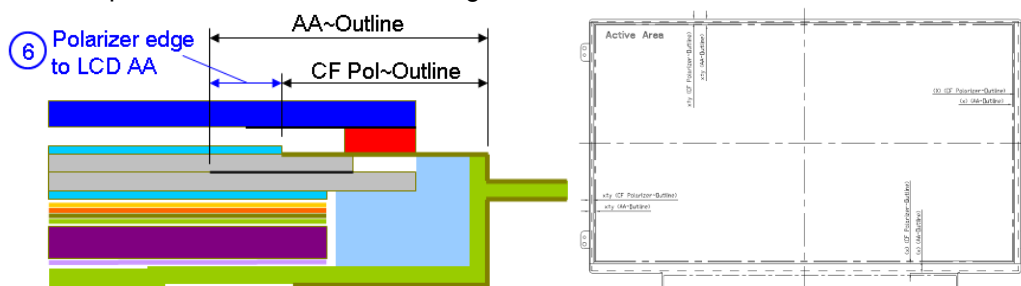
<p>Definition</p>	<p>System rear-cover material with high rigidity is needed to resist deformation during scuffing test, hinge test, pogo test, or backpack test. Abnormal display, white spot, pooling issue may occur if low rigidity material is used. Pooling issue may occur because screw's boss positioning for module's bracket are deformed during open-close test. Solid structure design of system rear-cover may also influence the rigidity of system rear-cover. The deformation of system rear-cover should not caused interference.</p>
<p>9</p>	<p>System base unit design near keyboard and mouse pad</p>
	
<p>Definition</p>	<p>To prevent abnormal display & white spot after scuffing test, hinge test, pogo test, backpack test, sharp edge design in keyboard surface may damage panel during the test. We suggest to use slope edge design, or to reduce the thickness difference of keyboard/mouse pad from the nearby surface.</p>
<p>10</p>	<p>Screw boss height design</p>
	
<p>Definition</p>	<p>Screw boss height should be designed with respect to the height of bracket bottom surface to panel bottom surface + flatness change of panel itself. Because gap will exist between screw boss and bracket, if the screw boss height is smaller. As result while fastening screw, bracket will deformed and pooling issue may occur.</p>
<p>11</p>	<p>Assembly SOP examination for system front-cover with Hook design</p>
	

Definition	To prevent panel crack during system front-cover assembly process with hook design, it is not recommended to press panel or any location that related directly to the panel.
12	Assembly SOP examination for system front-cover with Double tape design
Definition	To prevent panel crack during system front-cover assembly process with double tape design, it is only allowed to give slight pressure (MAX 3 Kgf/50mm ²) with large contact area. This can help to distribute the stress and prevent stress concentration. We also suggest putting the system on a flat surface stage to prevent unequal stress distribution during the assembly.
13	System front-cover assembly reference with Double tape design
Definition	To prevent system front-cover peeling at double tape contact area, Height difference between system front-cover assembly reference such as wall or components stack (wire, spacer) and double tape top surface must be less than 0.05mm.
14	Touch Application : TP and LCD Module Combination for White Line Prevention



Parameter consideration for White Line Issue :	
1	TP VA to LCD AA distance
2	TP Assembly tolerance
3	TP Ink Printing tolerance
4	Sponge thickness and tolerance
5	Inspection/Viewing Angle specification
6	Polarizer edge to LCD AA distance and tolerance

Polarizer edge to LCD AA distance can be derived by "AA~Outline" – "CF Pol~Outline" with respect to INX 2D Outline Drawing on each side.



Definition

For using in Touch Application: to prevent White Line appears between TP and LCD module combination, the maximum inspection angle location must not fall onto LCD polarizer edge, otherwise light line near edge of polarizer will be appear.








Parameters such as TP VA to LCD AA distance, TP assembly tolerance, TP Ink printing tolerance, Sponge thickness and tolerance, and Maximum Inspection/Viewing Angle, must be considered with respect to LCD module's Polarizer edge location and tolerance. This consideration must be taken at all four edges separately.



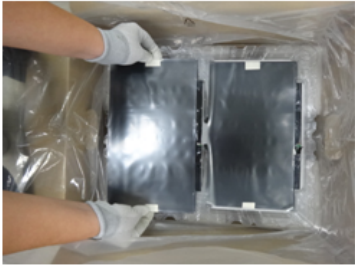
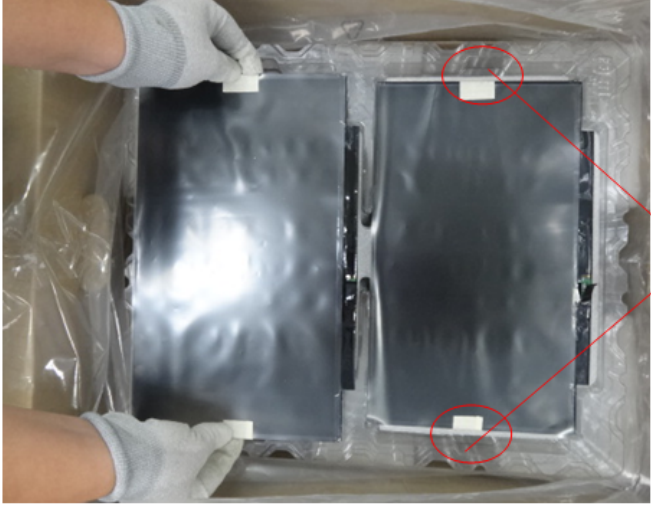
The goal is to find parameters combination that allow maximum inspection angle falls inside polarizer black margin area.

Note: Information for Polarizer edge location and its tolerance can be derived from INX 2D Outline Drawing ("AA ~Outline" - "CF Pol~Outline").

Note: Please feel free to contact INX FAE Engineer. By providing value of parameters above on each side, we can help to verify and pass the white line risk feasibility for your reference.

Appendix. LCD MODULE HANDLING MANUAL

<p>Purpose</p>	<ul style="list-style-type: none"> • This SOP is prepared to prevent panel dysfunction possibility through incorrect handling procedure. • This manual provides guide in unpacking and handling steps. • Any person which may contact / related with panel, should follow guide stated in this manual to prevent panel loss.
<p>1.</p>	<p>Unpacking</p>
<div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  </div> <div style="text-align: center;"> <p>Open carton</p>  </div> <div style="text-align: center;"> <p>Remove EPE Cushion</p>  </div> </div> <div style="text-align: center; margin: 10px 0;">  </div> <div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  </div> <div style="text-align: center;"> <p>Cut Adhesive Tape</p>  </div> <div style="text-align: center;"> <p>Remove EPE Cushion</p>  </div> </div> <div style="display: flex; justify-content: space-around; align-items: center; margin-top: 10px;"> <div style="text-align: center;"> <p>Open plastic bag</p> </div> </div>	
<p>2.</p>	<p>Panel Lifting</p>

Remove PET Cover	Remove PE Foam	Handle with care (see next page)	
			
			<p>Finger Slot</p> <p>Use slots at both sides for finger insertion. Handle panel upward with care.</p>
3.	Do and Don't		

Do :

- Handle with both hands.
- Handle panel at left and right edge.



Don't :

- Lifting with one hand.

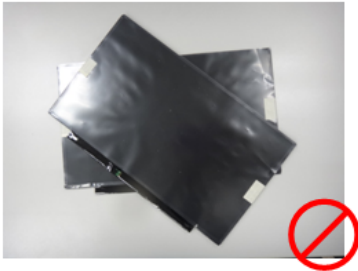


- Handle at PCBA side.



Don't :

- Stack panels.



- Press panel.



Don't :

- Put foreign stuff onto panel



- Put foreign stuff under panel



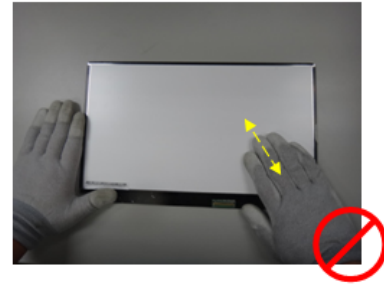
Don't :

- Paste any material unto white reflector sheet



Don't :

- Pull / Push white reflector sheet



Don't :

- Hold at panel corner.



Don't :

- Twist panel.



Do :

- Hold panel at top edge while inserting connector.



Don't :

- Press white reflector sheet while inserting connector.



Do :

- Remove panel protector film starts from side tape.



Don't :

- Remove panel protector film from film corner directly before side tape is removed.



Don't :

- Touch or Press PCBA Area.



Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

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